

## Editorial

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# EITEE embarks on a new journey

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In alignment with the proposal of the Chinese Academy of Engineering (CAE) and its flagship journal *Engineering*, to promote the “ENGINEERING” brand of CAE journals, the journal *Frontiers of Information Technology & Electronic Engineering* will be renamed *ENGINEERING Information Technology & Electronic Engineering* (abbreviated as *EITEE*) starting January 2026. This issue marks the inaugural use of the new name.

Although the name has changed, our focus remains steadfast: We are committed to exploring cutting-edge developments in information and electronic engineering. Our editorial principles continue to emphasize the promotion of original research, the encouragement of innovations with practical applications, the fostering of interdisciplinary collaboration, the upholding of rigorous and fair peer review, and the maintenance of an international perspective. Our core mission, to serve scientific and technological progress and to extend the benefits of engineering wisdom to human development, remains unchanged.

As the ancient saying goes, “Change leads to progress.” In 2026, *EITEE* will also evolve.

New collaboration platform: We are leveraging the journal publishing platform AcadeMax from Zhejiang University Press and the journal publishing platform from CAE, and we are

partnering with IEEE Xplore to establish a global dissemination network.

New publishing model: We will fully transition to open access and implement article-by-article priority publishing to enhance both speed and reach.

New design and layout: We will introduce a technology-inspired cover design and a compact format to improve visual appeal and reading experience.

On behalf of the editorial board and office, we solicit your attention and support as we collaborate to establish *EITEE* as a trusted platform for academic exchange, benefiting researchers and industry professionals worldwide in the fields of information and electronics.



Yunhe PAN  
Editor-in-Chief



Aiguo FEI  
Editor-in-Chief

## 传承初心,革新致远: *EITEE* 开启新征程

按照中国工程院和《工程(英文)》期刊的统一部署,为凸显工程院院刊集群“工程”品牌,2026年1月起,本刊更名为《工程·信息与电子工程(英文)》(*ENGINEERING Information Technology & Electronic Engineering*,简称*EITEE*),本期首用新名。

刊名虽改,本刊的目标领域没有变,依旧瞄准信息与电子工程的前沿。本刊的办刊方针没有变,我们始终致力于推动原创研究,鼓励具有应用潜力的创新,推崇学科交叉,坚持严格、公正的同行评议,坚持走国际化办刊道路。本刊的核心使命也没有变——服务科技进步,让工程智慧惠及人类发展。

古人云,变则通。2026年,本刊也有与时俱进的变化。

新合作平台:依托浙江大学出版社AcadeMax期刊平台和中国工程院院刊平台,开启与IEEE Xplore的合作,构建全球传播网络。

新出版范式:全面转向开放获取,并实施按篇优先出版,提升出版速度与传播广度。

新设计排版:采用更富科技感的封面设计与紧凑版式,提升视觉与阅读体验。

我们谨代表全体编委和编辑部,诚挚期待您的关注、支持,共同将本刊打造成值得信赖的学术交流高地,服务全球信息电子领域学术与产业界科技人员。

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